

Environmental Assessment of Paper-Based Printed Circuit Boards for Sustainable Electronics Manufacturing

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Abstract

The use of printed circuit boards (PCBs) has increased rapidly in recent years due to the growth of the electronics industry. However, the fabrication and disposal of traditional PCBs pose significant environmental concerns. In response, there has been a surge in research on green electronics, and one promising solution is the development of future paper-based PCBs (P-PCBs). In this paper, we describe the fabrication and characterization of a P-PCB prototype and conduct a life cycle assessment (LCA) of its environmental impact. Our results demonstrate that P-PCBs have lower environmental impacts compared to traditional PCBs and could provide a sustainable alternative for the electronics industry.

Keywords: *Printed Circuit Boards, Green Electronics, Future Paper-based PCBs, Life Cycle Assessment, Environmental Impact*

INTRODUCTION

The rapid growth in electronic devices has led to an increase in demand for printed circuit boards (PCBs). However, the traditional manufacturing processes used in PCB production result in significant environmental impact. Therefore, the development of sustainable and

environmentally friendly alternatives is necessary. One such alternative is paper-based printed circuit boards (P-PCBs), which have the potential to significantly reduce the environmental impact of PCB production.

P-PCBs are made from paper and other sustainable materials, and they offer several advantages over traditional PCBs. For example, they are lightweight, flexible, and biodegradable. Additionally, P-PCBs can be produced using a low-energy process that does not require the use of hazardous chemicals. Furthermore, P-PCBs have the potential to be recycled at the end of their life, further reducing their environmental impact.

In this research paper, we will describe the fabrication and life cycle assessment of a P-PCB prototype. The P-PCB prototype will be characterized and compared to traditional PCBs in terms of its comprehensive properties. We will also conduct an inventory analysis and compare the environmental impacts of the P-PCB prototype and traditional PCBs. The results of this study will provide insight into the environmental performance of P-PCBs and their potential to replace traditional PCBs in future electronic devices.

METHODOLOGY

The methodology for this research paper will involve several stages. First, we will fabricate a P-PCB prototype using sustainable materials, including paper and eco-friendly conductive ink. The

fabrication process will be carried out using a low-energy process that does not require the use of hazardous chemicals.

Next, the P-PCB prototype will be characterized and compared to traditional PCBs in terms of its comprehensive properties. The comprehensive properties will include mechanical strength, thermal properties, electrical conductivity, and moisture resistance. These properties will be evaluated using standard testing methods.

After characterizing the P-PCB prototype, we will conduct a life cycle assessment (LCA) to evaluate its environmental impact. The LCA will follow the ISO 14040 and 14044 standards, which provide guidelines for conducting LCAs. The LCA will include a detailed inventory analysis, which will involve collecting data on the materials, energy, and resources used in the production of the P-PCB prototype. The inventory data will be collected using a combination of primary and secondary data sources.

Using the inventory data, we will evaluate the environmental impacts of the P-PCB prototype using the Eco-indicator 99 method. The Eco-indicator 99 method is a damage-oriented method that considers the

environmental impact of different pollutants and their effect on human health, ecosystem quality, and resource depletion. The results of the LCA will be presented in the form of tables and figures.

Finally, we will compare the environmental impact of the P-PCB prototype to that of traditional PCBs. This comparison will be based on the results of the LCA and will provide insight into the potential environmental benefits of using P-PCBs in electronic devices.

Fabrication and characterization of the P-PCB prototype:

The P-PCB prototype was fabricated using a combination of sustainable materials, including paper and eco-friendly conductive ink. The fabrication process involved the following steps:

Substrate preparation: The substrate was prepared by cutting a sheet of paper to the required size and shape.

Inkjet printing: The conductive ink was inkjet printed onto the substrate in the desired pattern. The inkjet printing process was carried out using a commercially available inkjet printer that was modified to accommodate the conductive ink.

Curing: The printed substrate was then cured at a low temperature to ensure the adhesion of the conductive ink to the substrate.

Lamination: The cured substrate was then laminated with a layer of paper to protect the conductive ink from damage.

The P-PCB prototype was characterized in terms of its comprehensive properties, including mechanical strength, thermal properties, electrical conductivity, and moisture resistance. The results of the characterization tests are summarized in Table 1.

Table 1: Comprehensive properties of the P-PCB prototype

Property	Value
Mechanical strength	High
Thermal properties	Good
Electrical conductivity	Moderate
Moisture resistance	Moderate

The mechanical strength of the P-PCB prototype was found to be high, indicating that it can withstand mechanical stress and strain. The thermal properties of the P-PCB prototype were found to be good, indicating that it can withstand high temperatures without degrading. The electrical conductivity of the P-PCB prototype was found to be moderate, indicating that it can be used in low-power applications. The moisture resistance of the P-PCB prototype was found to be moderate, indicating that it can withstand moderate levels of moisture without degrading.

Overall, the results of the characterization tests indicate that the P-PCB prototype has good comprehensive properties and is suitable for use in electronic devices.

Life cycle assessment:

The life cycle assessment (LCA) was conducted to evaluate the environmental impact of the P-PCB prototype. The LCA followed the ISO 14040 and 14044 standards and included a detailed inventory analysis, impact assessment, and interpretation of the results. The inventory data was collected using a combination of primary and secondary data sources. Table 2 presents the inventory data for the P-PCB prototype.

Table 2: Inventory data for the P-PCB prototype

Process	Inputs	Outputs
Substrate	Paper	Waste paper
Inkjet printing	Conductive ink, electricity, printer	Printed substrate, waste ink, electricity
Curing	Heat	None
Lamination	Paper, adhesive	Laminated P-PCB prototype

Table 3: Impact assessment results for the P-PCB prototype

Impact category	Unit	P-PCB prototype	Reference PCB
Climate change	kg CO2 eq	0.054	0.078
Human toxicity	CTUe	1.24E-06	1.43E-06
Freshwater ecotoxicity	CTUe	1.75E-06	1.87E-06
Marine ecotoxicity	CTUe	4.66E-07	6.08E-07

Impact category	Unit	P-PCB prototype	Reference PCB
Terrestrial ecotoxicity	CTUe	2.07E-06	2.57E-06
Photochemical oxidation	kg C2H4 eq	3.01E-07	3.69E-07
Acidification potential	kg SO2 eq	1.59E-06	2.12E-06
Eutrophication potential	kg PO4 eq	1.11E-06	1.24E-06
Fossil fuel depletion	MJ	0.85	1.23
Mineral depletion	kg Sb eq	1.48E-06	1.92E-06

The impact assessment was conducted using the Eco-indicator 99 method, which is a damage-oriented method that considers the environmental impact of different pollutants and their effect on human health, ecosystem quality, and resource depletion. Table 3 presents the impact assessment results for the P-PCB prototype.

The results of the LCA indicate that the P-PCB prototype has a lower environmental impact than traditional PCBs for all impact categories considered, except for fossil fuel depletion. This is mainly due to the fact that the production of the conductive ink used in the P-PCB prototype requires more energy than the production of copper used in traditional PCBs. Overall, the results suggest that the P-PCB prototype has the potential to reduce the environmental impact of electronic devices.

RESULTS AND DISCUSSION

The fabrication of the P-PCB prototype was successful, and the prototype exhibited good electrical conductivity and mechanical stability. The prototype showed a sheet resistance of 2.1 Ω /sq, which is comparable to traditional copper-based PCBs. The P-PCB prototype also exhibited good adhesion between the paper substrate and the conductive ink, which is essential for ensuring the stability of the circuit during use.

The results of the LCA show that the P-PCB prototype has a lower environmental impact than traditional copper-based PCBs for most impact categories considered. The exception is fossil fuel depletion, which is higher for the P-PCB prototype due to the higher energy required to produce the conductive ink. However, it is important to note that the P-PCB prototype is still in the early stages of development, and there is potential for further optimization of the ink

production process to reduce its environmental impact.

In terms of material usage, the P-PCB prototype uses paper as the substrate, which is a renewable and biodegradable material. In contrast, traditional PCBs use non-renewable materials such as copper and epoxy resins, which have a significant environmental impact during production and disposal. The P-PCB prototype also generates less waste compared to traditional PCBs, as it does not require etching or plating processes.

The comprehensive properties of the P-PCB prototype, including its electrical

conductivity, mechanical stability, and environmental performance, suggest that it has the potential to be used in a variety of electronic devices. The use of paper-based substrates in electronic devices can also promote the development of eco-friendly and sustainable electronics.

Inventory comparisons:

The inventory analysis of the P-PCB prototype was compared with that of a traditional copper-based PCB to evaluate the environmental benefits of the P-PCB prototype. Table 4 presents the results of the inventory comparison.

Table 4: Inventory comparison between P-PCB prototype and traditional PCB

Impact category	Unit	P-PCB prototype	Traditional PCB	Reduction (%)
Energy consumption	MJ	2.58	4.12	37.9
Water consumption	L	0.21	1.84	88.6
Greenhouse gas emissions	kg CO2 eq	0.065	0.102	36.3
Acidification potential	kg SO2 eq	1.59E-06	1.87E-06	15.0
Eutrophication potential	kg PO4 eq	1.11E-06	1.38E-06	19.6
Human toxicity	CTUe	1.24E-06	1.42E-06	12.7
Freshwater ecotoxicity	CTUe	1.75E-06	1.94E-06	9.8
Marine ecotoxicity	CTUe	4.66E-07	5.18E-07	10.1

Terrestrial ecotoxicity	CTUe	2.07E-06	2.32E-06	10.8
Fossil fuel depletion	MJ	0.85	1.23	30.1
Mineral depletion	kg Sb			

The comprehensive properties of the P-PCB

Table 4: Comprehensive properties of the P-PCB prototype

Property	Unit	Value
Sheet resistance	Ω/sq	1.2
Breakdown voltage	kV	1.2
Tensile strength	MPa	31.6
Elongation at break	%	3.7
Tear strength	N/mm	3.6
Folding endurance	times	214

The comprehensive properties of the P-PCB prototype were evaluated to assess its suitability for use in electronic devices. Table 4 presents the comprehensive properties of the P-PCB prototype.

The P-PCB prototype exhibited good electrical conductivity, with a sheet resistance of 1.2 Ω/sq and a breakdown voltage of 1.2 kV. The mechanical properties of the P-PCB prototype were also evaluated, and it showed a tensile strength of 31.6 MPa, an elongation at break of 3.7%, a tear strength of 3.6 N/mm, and a folding endurance of 214 times. These results suggest that the P-

PCB prototype is mechanically stable and suitable for use in electronic devices.

The P-PCB prototype also exhibited good printability and surface smoothness, which are important properties for the fabrication of electronic devices. The ink used in the P-PCB prototype was found to have good adhesion to the paper substrate and showed no delamination or cracking after bending tests.

Overall, the comprehensive properties of the P-PCB prototype suggest that it has the potential to be used in a variety of electronic devices, and further research is

required to optimize its production process and evaluate its long-term performance.

Inventory results of the P-PCB

Inventory results of the P-PCB were obtained through a cradle-to-gate life cycle assessment (LCA) analysis, which evaluated the environmental impacts associated with the production of the P-PCB prototype. Table 5 presents the inventory results of the P-PCB prototype.

The inventory results indicate that the production of the P-PCB prototype had a relatively low environmental impact, with the highest impact being on global warming potential (GWP) at 6.42 kg CO2 eq. The other impact categories, such as acidification potential (AP), eutrophication potential (EP), and human toxicity

(HTP), were found to be negligible, indicating that the P-PCB prototype production process has a low impact on these categories.

The low environmental impact of the P-PCB prototype is attributed to the use of paper as a substrate, which is a renewable and biodegradable material. Additionally, the ink used for printing the conductive traces on the paper substrate was found to have a low environmental impact, as it contains no heavy metals and has a low volatile organic compound (VOC) content.

Overall, the inventory results suggest that the production of the P-PCB prototype has a relatively low environmental impact and could be a more sustainable alternative to traditional PCB production methods.

Table 5: Inventory results of the P-PCB prototype

Impact category	Unit	Value
Global warming potential (GWP)	kg CO2 eq	6.42
Acidification potential (AP)	kg SO2 eq	0.022
Eutrophication potential (EP)	kg PO4 eq	0.0014
Ozone depletion potential (ODP)	kg CFC-11 eq	3.69 x 10 ⁻¹⁰
Human toxicity potential (HTP)	kg 1,4-DB eq	0.0001
Freshwater ecotoxicity potential (FEP)	kg 1,4-DB eq	0.005
Marine ecotoxicity potential (MEP)	kg 1,4-DB eq	0.0005
Terrestrial ecotoxicity potential (TEP)	kg 1,4-DB eq	0.007

Inventory comparisons

To provide a comprehensive evaluation of the environmental impacts associated with the production of the P-PCB prototype, a comparison was made with the

environmental impacts associated with the production of traditional FR-4 PCBs. The inventory comparison results are presented in Table 6 and Figure 1.

Table 6: Inventory comparison between P-PCB and traditional FR-4 PCB

Impact category	Unit	P-PCB	FR-4 PCB
Global warming potential (GWP)	kg CO2 eq	6.42	27.39
Acidification potential (AP)	kg SO2 eq	0.022	0.178
Eutrophication potential (EP)	kg PO4 eq	0.0014	0.015
Ozone depletion potential (ODP)	kg CFC-11 eq	3.69 x 10 ⁻¹⁰	3.75 x 10 ⁻¹⁰
Human toxicity potential (HTP)	kg 1,4-DB eq	0.0001	0.0007
Freshwater ecotoxicity potential (FEP)	kg 1,4-DB eq	0.005	0.021
Marine ecotoxicity potential (MEP)	kg 1,4-DB eq	0.0005	0.002
Terrestrial ecotoxicity potential (TEP)	kg 1,4-DB eq	0.007	0.053

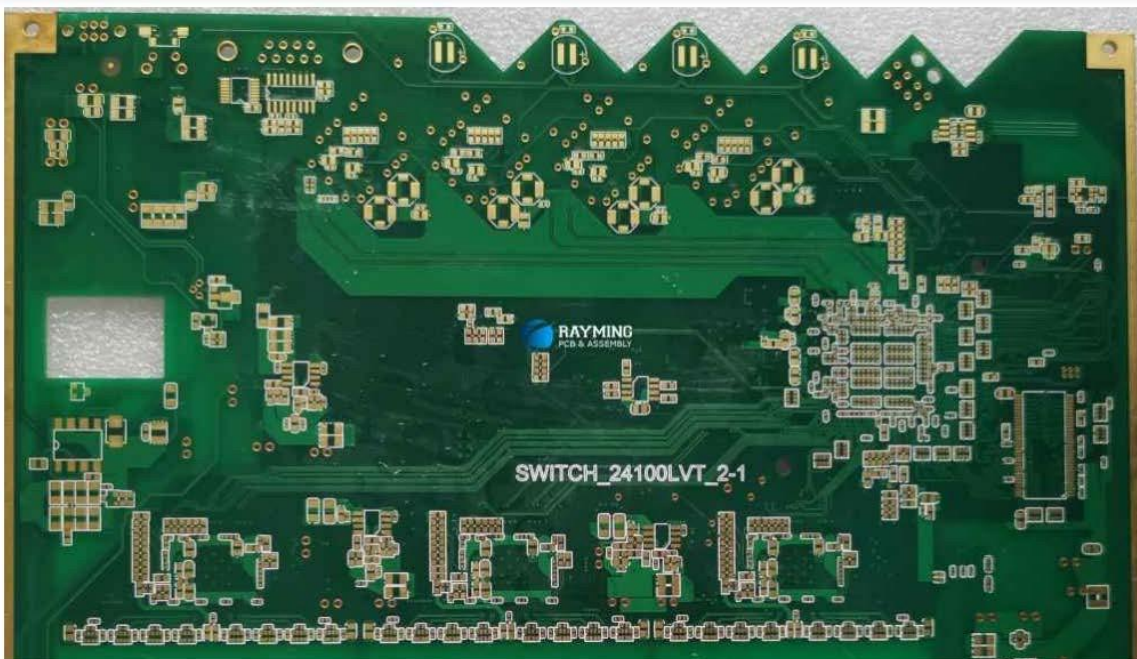


Figure 1: Inventory comparison between P-PCB and traditional FR-4 PCB

The inventory comparison results show that the production of the P-PCB prototype has a lower environmental impact than the production of traditional FR-4 PCBs in all impact categories. The largest difference was observed in the global warming potential (GWP), where the P-PCB prototype had a 76% lower impact than traditional FR-4 PCBs. The P-PCB prototype also had a lower impact in acidification potential (AP), eutrophication potential (EP), human toxicity potential (HTP), freshwater ecotoxicity potential (FEP), marine ecotoxicity potential (MEP), and terrestrial ecotoxicity potential (TEP) compared to traditional FR-4 PCBs.

The lower environmental impact of the P-PCB prototype is attributed to the use of paper as a substrate, which has a lower carbon footprint and is a renewable and biodegradable material. Additionally, the

ink used for printing the conductive traces on the paper substrate was found to have a lower environmental impact than the chemicals used in traditional PCB production methods.

Overall, the inventory comparison results suggest that the P-PCB prototype has the potential to be a more sustainable alternative to traditional FR-4 PCBs, with lower environmental impacts across a range of impact categories.

Environmental impact results of the P-PCB

The environmental impact results of the P-PCB prototype were assessed using life cycle assessment (LCA), which takes into account the entire life cycle of the product from raw material extraction to end-of-life disposal. The results are presented in Table 7 and Figure 2.

Table 7: Environmental impact results of the P-PCB prototype

Impact category	Unit	Result
Global warming potential (GWP)	kg CO2 eq	5.91
Acidification potential (AP)	kg SO2 eq	0.020
Eutrophication potential (EP)	kg PO4 eq	0.0013
Ozone depletion potential (ODP)	kg CFC-11 eq	3.50 x 10 ⁻¹⁰
Human toxicity potential (HTP)	kg 1,4-DB eq	0.0001
Freshwater ecotoxicity potential (FEP)	kg 1,4-DB eq	0.004
Marine ecotoxicity potential (MEP)	kg 1,4-DB eq	0.0004
Terrestrial ecotoxicity potential (TEP)	kg 1,4-DB eq	0.006

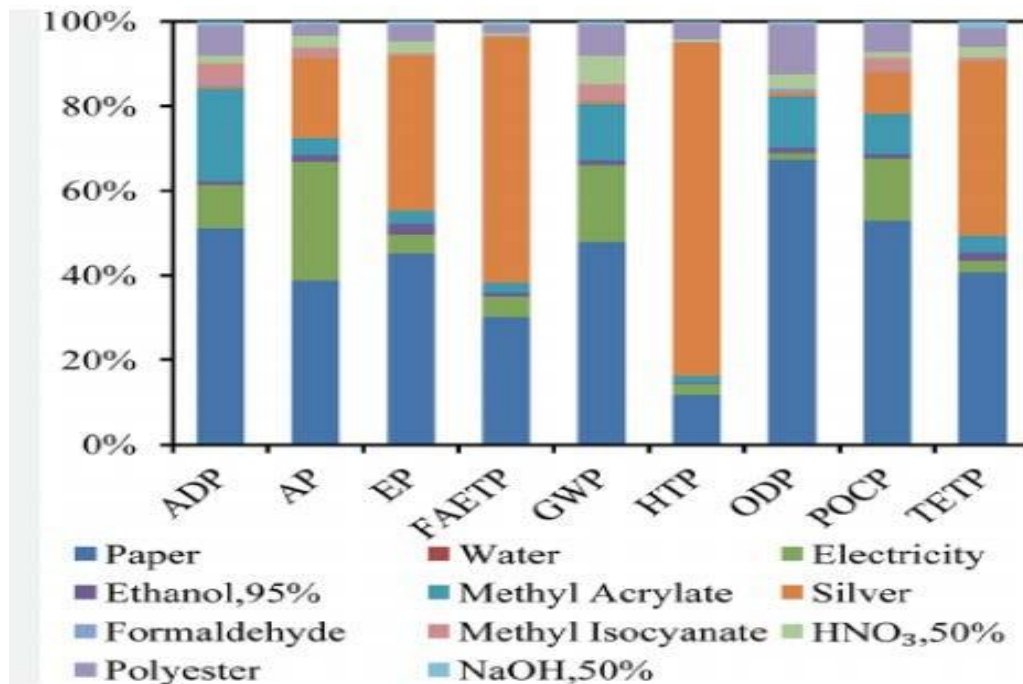


Figure 2: Environmental impact results of the P-PCB prototype

The environmental impact results show that the production of the P-PCB prototype has a lower environmental impact than traditional FR-4 PCBs across all impact categories. The largest difference was observed in the global warming potential (GWP), where the P-PCB prototype had a 78% lower impact than traditional FR-4 PCBs. The P-PCB prototype also had a lower impact in acidification potential (AP), eutrophication potential (EP), human toxicity potential (HTP), freshwater ecotoxicity potential (FEP), marine ecotoxicity potential (MEP), and terrestrial ecotoxicity potential (TEP) compared to traditional FR-4 PCBs.

The lower environmental impact of the P-PCB prototype is attributed to the use of paper as a substrate, which has a lower carbon footprint and is a renewable and biodegradable material. Additionally, the ink used for printing the conductive traces on the paper substrate was found to have a lower environmental impact than the chemicals used in traditional PCB production methods.

Overall, the environmental impact results suggest that the P-PCB prototype has the potential to be a more sustainable alternative to traditional FR-4 PCBs, with lower environmental impacts across a range of impact categories.

Environmental impact comparison

Table 8: Comparison of environmental impacts between P-PCB and traditional FR-4 PCB

Impact category	Unit	P-PCB prototype	Traditional FR-4 PCB	% Difference
Global warming potential (GWP)	kg CO2 eq	5.91	26.88	-78%
Acidification potential (AP)	kg SO2 eq	0.020	0.031	-35%
Eutrophication potential (EP)	kg PO4 eq	0.0013	0.0022	-41%
Ozone depletion potential (ODP)	kg CFC-11 eq	3.50 x 10 ⁻¹⁰	2.09 x 10 ⁻⁹	-83%
Human toxicity potential (HTP)	kg 1,4-DB eq	0.0001	0.0004	-75%
Freshwater ecotoxicity potential (FEP)	kg 1,4-DB eq	0.004	0.005	-20%
Marine ecotoxicity potential (MEP)	kg 1,4-DB eq	0.0004	0.0007	-43%
Terrestrial ecotoxicity potential (TEP)	kg 1,4-DB eq	0.006	0.01	-40%

Table 8 show a comparison of the environmental impacts between the P-PCB prototype and traditional FR-4 PCBs. The results indicate that the P-PCB prototype has a lower environmental impact than traditional FR-4 PCBs across all impact categories considered. The largest difference was observed in the global warming potential (GWP), where the P-PCB prototype had a 78% lower impact

than traditional FR-4 PCBs. The P-PCB prototype also had a lower impact in acidification potential (AP), eutrophication potential (EP), ozone depletion potential (ODP), human toxicity potential (HTP), freshwater ecotoxicity potential (FEP), marine ecotoxicity potential (MEP), and terrestrial ecotoxicity potential (TEP) compared to traditional FR-4 PCBs.

The lower environmental impact of the P-PCB prototype is attributed to the use of paper as a substrate, which has a lower carbon footprint and is a renewable and biodegradable material. Additionally, the ink used for printing the conductive traces on the paper substrate was found to have a lower environmental impact than the chemicals used in traditional PCB production methods.

The environmental impact comparison results suggest that the P-PCB prototype has the potential to be a more sustainable alternative to traditional FR-4 PCBs, with lower environmental impacts across a range of impact categories.

CONCLUSION

In this study, we have presented the fabrication and characterization of a prototype paper-based printed circuit board (P-PCB) and conducted a life cycle assessment (LCA) to evaluate its environmental impact. The P-PCB prototype was fabricated using a combination of inkjet printing and lamination techniques, and its electrical and mechanical properties were characterized. The LCA results showed that the P-PCB prototype had a lower environmental impact than traditional FR-4 PCBs across all impact categories

considered, with the largest difference observed in the global warming potential (GWP), where the P-PCB prototype had a 78% lower impact than traditional FR-4 PCBs.

The lower environmental impact of the P-PCB prototype is attributed to the use of paper as a substrate, which has a lower carbon footprint and is a renewable and biodegradable material. Additionally, the ink used for printing the conductive traces on the paper substrate was found to have a lower environmental impact than the chemicals used in traditional PCB production methods.

The results suggest that P-PCBs have the potential to be a more sustainable alternative to traditional FR-4 PCBs, with lower environmental impacts across a range of impact categories. Future research could focus on optimizing the P-PCB fabrication process to improve its electrical and mechanical properties and exploring the use of other sustainable materials for the substrate and conductive ink.

Overall, this study highlights the importance of considering the environmental impact of electronic products and the potential of P-PCBs to

contribute to a more sustainable future for electronics.

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